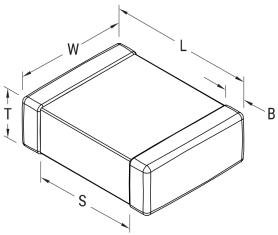


C1812X473J2GACTU

Aliases (C1812X473J2GAC7800)

SMD Comm COG Flex, Ceramic, 0.047 uF, 5%, 200 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1812



Click here for the 3D model.

Dimensions	
Chip Size	1812
L	4.5mm +/-0.4mm
W	3.2mm +/-0.3mm
Т	1.25mm +/-0.15mm
S	2.3mm MIN
В	0.7mm +/-0.35mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	1000

General Information		
Series	SMD Comm COG Flex	
Style	SMD Chip	
Description	SMD, MLCC, FT-CAP, Ultra-Stable	
Features	FT-CAP, Ultra-Stable	
RoHS	Yes	
Termination	Flexible Termination	
Marking	false	
AEC-Q200	No	
Typical Component Weight	67 mg	
Shelf Life	78 Weeks	
MSL	1	

Specifications	
Capacitance	0.047 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	200 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	21.2766 GOhms

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